

Title (en)

Fast and low temperature cured polyimide fuser belt

Title (de)

Polyimid-Fixiergürtel, der schnell und bei geringer Temperatur gehärtet wird

Title (fr)

Ceinture à fusion en polyimide durci à basse température et rapidement

Publication

**EP 2309338 A1 20110413 (EN)**

Application

**EP 09171837 A 20090930**

Priority

EP 09171837 A 20090930

Abstract (en)

A belt material and methods for making and using the belt material are described. The belt material may be a fast and low-temperature cured polyimide belt that includes a plurality of thermally-conductive species dispersed in a polyimide resin. The belt material may include one or more layers formed over the fast and low-temperature cured polyimide belt substrate that includes a plurality of thermally-conductive species dispersed in the polyimide resin. For example, the fast and low-temperature cured polyimide belt or belt substrate can be cured at a temperature of about 300°C or lower for a time length of less than about one hour. The belt material is suitable for use in an electrostatographic printing process as a fuser belt, a fixing belt, a pressure belt, and/or a release agent donor belt.

IPC 8 full level

**G03G 15/20** (2006.01)

CPC (source: EP)

**G03G 15/2057** (2013.01); **G03G 2215/2035** (2013.01)

Citation (search report)

- [XY] WO 2008120787 A1 20081009 - UBE INDUSTRIES [JP], et al & EP 2141187 A1 20100106 - UBE INDUSTRIES [JP]
- [YA] JP H1112500 A 19990119 - HITACHI CHEMICAL CO LTD
- [Y] JP 2005258432 A 20050922 - IST KK

Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

Designated extension state (EPC)

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DOCDB simple family (publication)

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